



MMST4403

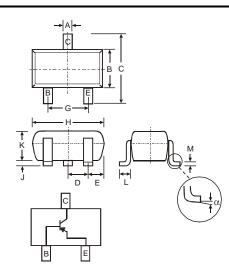
PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMST4401)
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Lead Free Plating (Matte Tin Finish annealed over
- Alloy 42 leadframe).
- Marking Information: K3T See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.006 grams (approximate)



SOT-323									
Dim	Min	Max 0.40							
Α	0.25								
В	1.15	1.35							
С	2.00	2.20							
D	0.65 N	ominal							
Е	0.30 0.40								
G	1.80	1.40							
н	1.80	2.20							
J	0.0	0.10							
к	0.90	1.00							
L	0.25	0.40							
М	0.10	0.18							
α	0°	8°							
All Dimensions in mm									

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current – Continuous (Note 1)	Ι _C	-600	mA
Power Dissipation (Note 1)	Pd	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{θJA}	625	K/W
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150	°C

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout

document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

2. No purposefully added lead.

3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

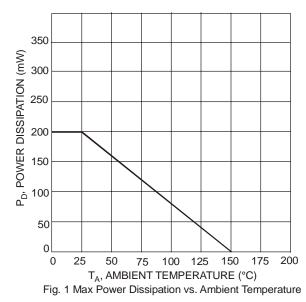
4. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants..

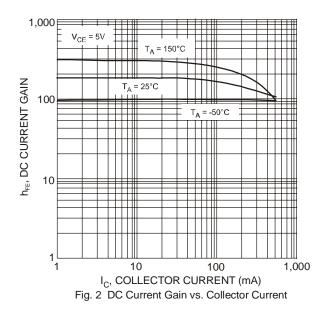


Electrical Characteristics @T_A = 25°C unless otherwise specified

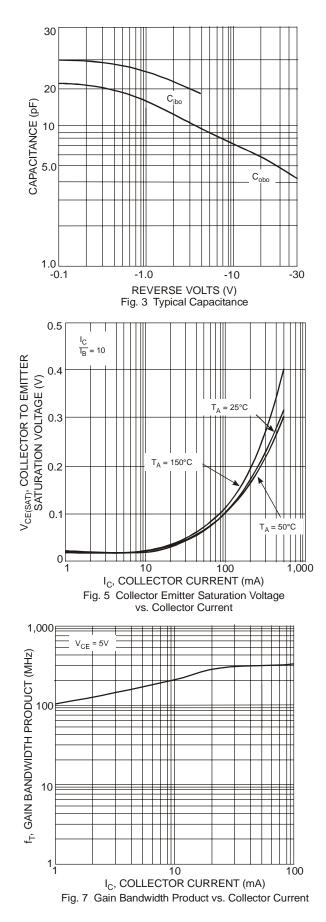
Characteristic	Symbol	Min	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 5)	L L				1		
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-40		V	$I_{C} = -100 \mu A, I_{E} = 0$		
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-40		V	$I_{\rm C} = -1.0 {\rm mA}, I_{\rm B} = 0$		
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5.0		V	$I_{\rm E} = -100 \mu A, I_{\rm C} = 0$		
Collector Cutoff Current	I _{CEX}	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
Base Cutoff Current	I _{BL}	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
ON CHARACTERISTICS (Note 5)							
DC Current Gain	h _{FE}	30 60 100 100 20	 300	_	$ \begin{array}{l} I_{C}=-100\mu A, \ V_{CE}=-1.0V \\ I_{C}=-1.0m A, \ V_{CE}=-1.0V \\ I_{C}=-10m A, \ V_{CE}=-1.0V \\ I_{C}=-150m A, \ V_{CE}=-2.0V \\ I_{C}=-500m A, \ V_{CE}=-2.0V \end{array} $		
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-0.40 -0.75	V	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA		
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.75	-0.95 -1.30	V	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA		
SMALL SIGNAL CHARACTERISTICS			•				
Output Capacitance	Cob	_	8.5	pF	V _{CB} = -10V, f = 1.0MHz, I _E = 0		
Input Capacitance	C _{eb}		30	pF	$V_{EB} = -0.5V, f = 1.0MHz, I_{C} = 0$		
Input Impedance	h _{ie}	1.5	15	kΩ			
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = -10V, I _C = -1.0mA,		
Small Signal Current Gain	h _{fe}	h _{fe} 60 500 —		_	f = 1.0MHz		
Output Admittance	h _{oe}	1.0	100	μS			
Current Gain-Bandwith Product	f _T	200	_	MHz	$V_{CE} = -10V, I_C = -20mA,$ f = 100MHz		
SWITCHING CHARACTERISTICS	·				_		
Delay Time	t _d	_	15	ns	V _{CE} = -30V, I _C = -150mA,		
Rise Time	tr	_	20	ns	$V_{BE(OFF)} = -2.0V, I_{B1} = -15mA$		
Storage Time	ts	_	225	ns	V _{CE} = -30V, I _C = -150mA,		
Fall Time	tr		30	ns	$I_{B1} = I_{B2} = -15 \text{mA}$		

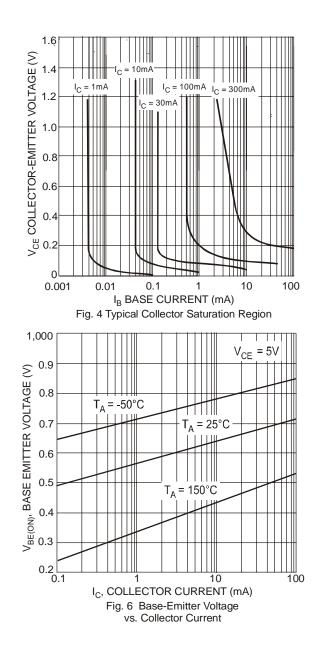
Notes: 5. Short duration pulse test used to minimize self-heating effect













Ordering Information (Note 4 and 6)

Device	Packaging	Shipping				
MMST4403-7-F	SOT-323	3000/Tape & Reel				

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

Date Code Key			 к	ЗТ	Σ	K3T = Pi YM = Da Y = Year M = Mon	te Code ex: N =	Markin 2002	g	de					
Year	1998	1999	2000	200	1 2002	2003	2004	2005	2006	2007	2008	2009	201	0 2011	2012
Code	J	K	L	Μ	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	F	eb	Mar	Apr	May	Ju	in	Jul	Aug	Sep	Oc	t	Nov	Dec
Code	1		2	3	4	5	6	;	7	8	9	0)	Ν	D

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